



JAE Electronics, Inc.  
November 8<sup>th</sup>, 2016

## PCN (Process Change Notice) MX34028SF1 Additional Mold Die Created To Keep Production Capacity

Part Number	2 Existing Mold Die with 4 Cavities	An Additional Mold Die with 2 Cavities	Additional Mold Die Completion	Proposed PPAP Submission	Start of Mass Production (SOP)
MX34028SF1	(F&G), (H&J)	(K&L)	First of February 2017	Middle of February 2017	End of March 2017

Notes:

- PC = Process Change (in Tooling: Transfer, Replacement, Refurbishment, or additional and Parts Produced at Additional Location, etc...)
- PPAP = Production Part Approval Process

1. PC PPAP will only be prepared and provided to customer who already requested and received Initial PPAP before.
2. If you need PC PPAP documents, please notify us no later than **11/15/16** in order for factory to prepare and submit by the proposed time.

For any questions regarding this matter, please contact Nina Duong at [duongn@jae.com](mailto:duongn@jae.com)

**Thank you very much for your cooperation!**